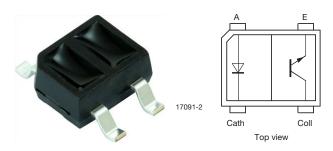


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## Vishay Semiconductors

# **Reflective Optical Sensor with Transistor Output**



### **DESCRIPTION**

The TCNT2000 is a reflective sensor in a miniature SMD package. It has a compact construction where the emitting light source and the detector are arranged in the same plane. The operating infrared wavelength is 940 nm. The detector consists of a silicon phototransistor. The sensor analog output signal (photo current) is triggered by detection of reflected infrared light from a close by object.

The sensor has a built in daylight blocking filter, which greatly suppresses disturbing ambient light and therefore increases signal to noise ratio.

#### **FEATURES**

· Package type: SMD

• Detector type: phototransistor

• Dimensions (L x W x H in mm): 3.4 x 2.7 x 1.5

 Operating range within > 20 % relative collector current: 0.2 mm to 5 mm

• Emitter wavelength: 940 nm

• Moisture sensitivity level (MSL): 3

 Material categorization: For definitions of compliance please see www.vishay.com/doc?99912





#### ROHS COMPLIANT HALOGEN FREE

## **APPLICATIONS**

- Position sensor
- · Optical switch
- Optical encoder (e.g. disc and tape drives for DVD and/or camera applications)
- Object detection (e.g. paper presence in printer and copy machines)

F	PRODUCT SUMMARY					
PART NUMBER		DISTANCE FOR MAXIMUM CTR <sub>rel</sub> (1) (mm)	DISTANCE RANGE FOR RELATIVE I <sub>out</sub> > 20 % (mm)	TYPICAL OUTPUT CURRENT UNDER TEST <sup>(2)</sup> (mA)	DAYLIGHT BLOCKING FILTER INTEGRATED	
Т	CNT2000	1	0.2 to 5	1.5	Yes	

#### Notes

- $^{(1)}$  CTR: current transfere ratio,  $I_{out}/I_{in}$
- (2) Conditions like in table basic charactristics/sensors

ORDERING INFORMATI	ON			
ORDERING CODE	PACKAGING	VOLUME (1)	REMARKS	
TCNT2000	Tape and reel	MOQ: 1000 pcs	Drypack, MSL 3	

## Note

(1) MOQ: minimum order quantity

PARAMETER	TEST CONDITION	CONDITION SYMBOL		UNIT		
INPUT (EMITTER)						
Reverse voltage		$V_{R}$	5	V		
Forward current		I <sub>F</sub>	100	mA		
Forward surge current	t <sub>p</sub> ≤ 100 μs	I <sub>FSM</sub>	500	mA		
OUTPUT (DETECTOR)						
Collector emitter breakdown voltage		V <sub>(BR)CEO</sub>	20	V		
Emitter collector voltage		V <sub>ECO</sub>	7	V		
Collector current		I <sub>C</sub>	20	mA		
SENSOR						
Total power dissipation	T <sub>amb</sub> ≤ 25 °C	P <sub>tot</sub>	170	mW		
Ambient temperature range		T <sub>amb</sub>	- 40 to + 85	°C		
Storage temperature range		T <sub>stg</sub>	- 40 to + 100	°C		
Soldering temperature	In accordance with fig. 11	T <sub>sd</sub>	260	°C		



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## **ABSOLUTE MAXIMUM RATINGS**

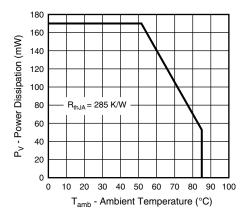


Fig. 1 - Power Dissipation vs. Ambient Temperature

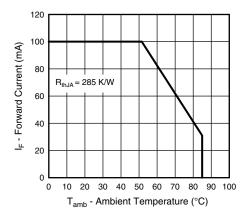


Fig. 2 - Forward Current vs. Ambient Temperature

<b>BASIC CHARACTERISTICS</b> (T <sub>amb</sub> = 25 °C, unless otherwise specified)							
PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT	
INPUT (EMITTER)							
Forward voltage	I <sub>F</sub> = 20 mA	V <sub>F</sub>		1.25	1.45	V	
Forward voltage	I <sub>F</sub> = 100 mA			1.4	1.7		
Temperature coefficient of V <sub>F</sub>	I <sub>F</sub> = 20 mA	TKV <sub>F</sub>		- 1.0		mV/K	
Peak wavelength	I <sub>F</sub> = 100 mA	$\lambda_{P}$		940		nm	
Reverse current	V <sub>R</sub> = 5 V	I <sub>R</sub>			10	μA	
OUTPUT (DETECTOR)							
Collector emitter breakdown voltage	$I_C = 0.1 \text{ mA, E} = 0$	V <sub>(BR)CEO</sub>	20			V	
Emitter collector voltage	$I_E = 100 \mu A, E = 0$	$V_{ECO}$	7			V	
Collector emitter dark current	$V_{CE} = 20 \text{ V}, E = 0$	I <sub>CEO</sub>		1	30	nA	
SENSOR							
Collector current	$V_{CE} = 5 \text{ V}, I_F = 20 \text{ mA}, d = 1 \text{ mm}$	I <sub>C</sub>	0.4	1.5	3.0	mA	
Current transfer ratio	$I_{C}/I_{F}$ , d = 1 mm, $V_{CE}$ = 5 V	CTR		4		%	
Rise time	$I_C = 0.8 \text{ mA}, V_{CE} = 5 \text{ V}, R_L = 100 \Omega$	t <sub>r</sub>		10	70	μs	
Fall time	$I_C = 0.8 \text{ mA}, V_{CE} = 5 \text{ V}, R_L = 100 \Omega$	t <sub>f</sub>		15	70	μs	

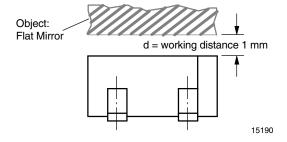


Fig. 3 - Test Circuit

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## **BASIC CHARACTERISTICS** (T<sub>amb</sub> = 25 °C, unless otherwise specified)

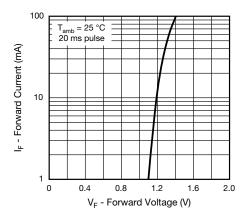


Fig. 4 - Forward Current vs. Forward Voltage

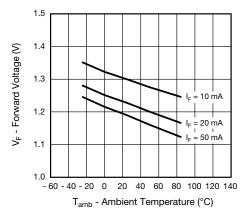


Fig. 5 - Forward Voltage vs. Ambient Temperature

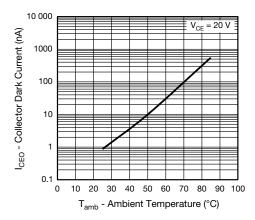


Fig. 6 - Collector Dark Current vs. Ambient Temperature

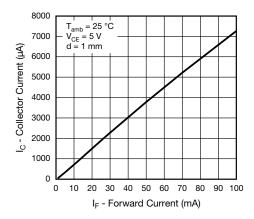


Fig. 7 - Collector Current vs. Forward Current

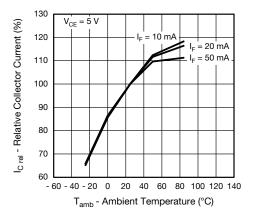


Fig. 8 - Relative Collector Current vs. Ambient Temperature

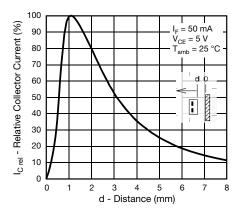


Fig. 9 - Relative Collector Current vs. Distance

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#### 110 I<sub>E</sub> = 20 mA I<sub>C rel</sub> - Relative Collector Current (%) 100 V<sub>CE</sub> = 5 V T<sub>amb</sub> = 25 °C 90 80 direction - direction 70 60 50 40 30 20 K 10 n - 3 - 2 3 s - Displacement (mm)

Fig. 10 - Relative Collector Current vs. Displacement

## PRECAUTIONS FOR USE

#### 1. Over-current-proof

Customer must apply resistors for protection, otherwise slight voltage shift will cause big current change (Burn out will happen).

## 2. Storage

- 2.1. Storage temperature and rel. humidity conditions are:  $5~^{\circ}\text{C}$  to  $30~^{\circ}\text{C}$ , RH  $60~^{\circ}$
- 2.2. Floor life must not exceed 168 h, acc. to JEDEC level 3, J-STD-020.

Once the package is opened, the products should be used within 168 h. Otherwise, they should be kept in a damp proof box with desiccant.

Considering tape life, we suggest to use products within one year from production date.

- 2.3 If opened more than 168 h in an atmosphere 5 °C to 30 °C, RH 60 %, devices should be treated at 60 °C  $\pm$  5 °C for 15 h.
- 2.4 If humidity indicator in the package shows pink color (normal blue), then devices should be treated with the same conditions as 2.3.

### **REFLOW SOLDER PROFILE**

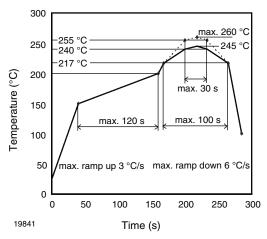


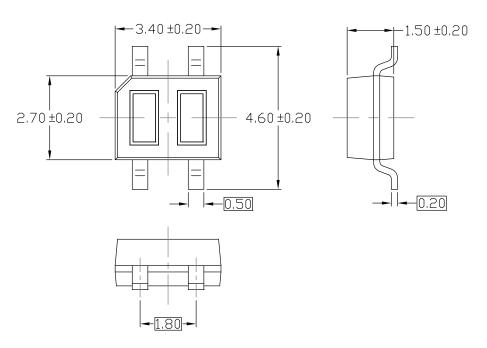
Fig. 11 - Lead (Pb)-free Reflow Solder Profile acc. J-STD-020

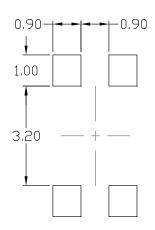
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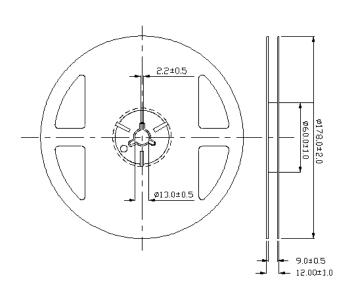
## **PACKAGE DIMENSIONS** in millimeters



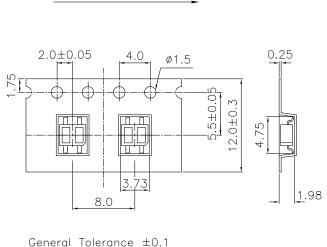


## **TAPE AND REEL DIMENSIONS** in millimeters: **TCNT2000**

1000 pcs/reel



Reel Dimensions



Progressive direction

UNIT:mm

Tape Dimensions



## **Legal Disclaimer Notice**

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